

LNPT™ THERMOTUF™ COMPOUND WF006I

WF-1006 HI
REGION AMERICAS

DESCRIPTION

LNP THERMOTUF WF006I compound is based on Polybutylene Terephthalate (PBT) resin containing 30% glass fiber. Added features of this grade include: Impact Modified.

GENERAL INFORMATION	
Features	High stiffness/Strength, Impact resistant, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polybutylene Terephthalate (PBT)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Building and Construction	Building Component
Consumer	Sport/Leisure, Personal Accessory, Home Appliances, Commercial Appliance
Electrical and Electronics	Mobile Phone - Computer - Tablets
Industrial	Electrical

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, yield	107	MPa	ASTM D638
Tensile Stress, break	106	MPa	ASTM D638
Tensile Strain, yield	3.2	%	ASTM D638
Tensile Strain, break	3.9	%	ASTM D638
Tensile Modulus, 50 mm/min	8960	MPa	ASTM D638
Flexural Stress	173	MPa	ASTM D790
Flexural modulus	7510	MPa	ASTM D790
Tensile Stress, yield	109	MPa	ISO 527
Tensile Strain, yield	2.1	%	ISO 527
Tensile Strain, break	2.8	%	ISO 527
Tensile Modulus, 1 mm/min	6520	MPa	ISO 527
Flexural Stress	181	MPa	ISO 178
Flexural Modulus	8620	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, unnotched, 23°C	998	J/m	ASTM D4812
Izod Impact, notched, 23°C	186	J/m	ASTM D256
Instrumented Dart Impact Energy @ peak, 23°C	17	J	ASTM D3763
Izod Impact, unnotched 80°10°4 +23°C	64	kJ/m ²	ISO 180/1U
Izod Impact, notched 80°10°4 +23°C	20	kJ/m ²	ISO 180/1A

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
THERMAL ⁽¹⁾			
HDT, 1.82 MPa, 3.2mm, unannealed	210	°C	ASTM D648
PHYSICAL ⁽¹⁾			
Density	1.474	g/cm ³	ASTM D792
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.3	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	1.3	%	ASTM D955
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.29	%	ISO 294
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	1.29	%	ISO 294
Density	1.47	g/cm ³	ISO 1183
INJECTION MOLDING ⁽³⁾			
Drying Temperature	120	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.05	%	
Melt Temperature	240 – 265	°C	
Front - Zone 3 Temperature	260 – 270	°C	
Middle - Zone 2 Temperature	245 – 255	°C	
Rear - Zone 1 Temperature	220 – 230	°C	
Mold Temperature	80 – 100	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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